
HAT2031T

Silicon N Channel Power MOS FET
High Speed Power Switching

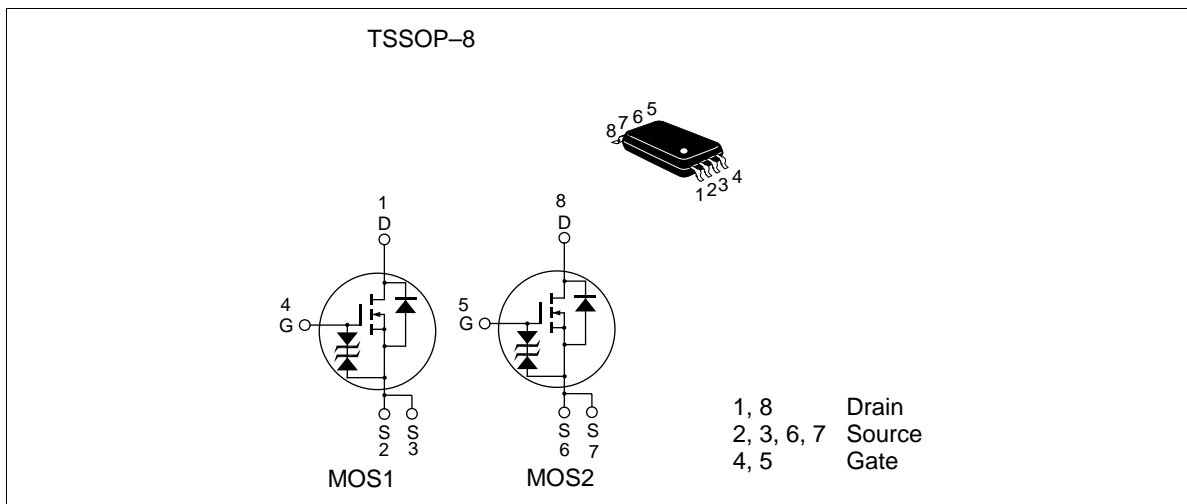
HITACHI

ADE-208-529F (Z)
7th. Edition
February 1999

Features

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

Outline



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Absolute Maximum Ratings (Ta = 25°C)

| Item | Symbol | Ratings | Unit |
|--|---------------------------------|---------------|------|
| Drain to source voltage | V_{DSS} | 20 | V |
| Gate to source voltage | V_{GSS} | ± 12 | V |
| Drain current | I_D | 3.5 | A |
| Drain peak current | $I_{D(pulse)}$ ^{Note1} | 28 | A |
| Body-drain diode reverse drain current | I_{DR} | 3.5 | A |
| Channel dissipation | P_{ch} ^{Note2} | 1 | W |
| Channel dissipation | P_{ch} ^{NoteCR} | 1.5 | W |
| Channel temperature | T_{ch} | 150 | °C |
| Storage temperature | T_{stg} | - 55 to + 150 | °C |

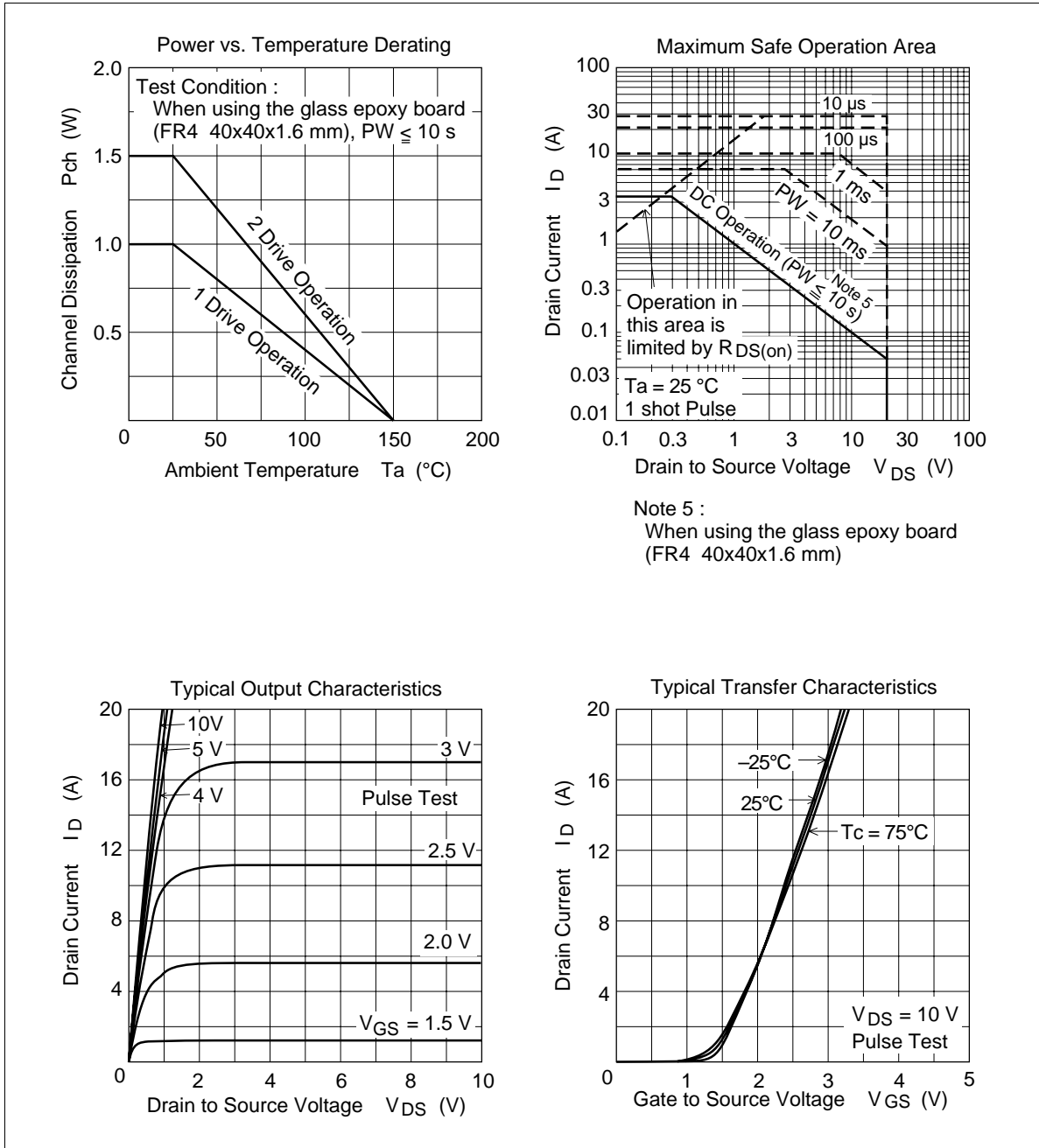
Note: 1. $PW \leq 10\mu s$, duty cycle $\leq 1\%$
 2. 1 Drive Operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), $PW \leq 10s$
 3. 2 Drive Operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), $PW \leq 10s$

Electrical Characteristics (Ta = 25°C)

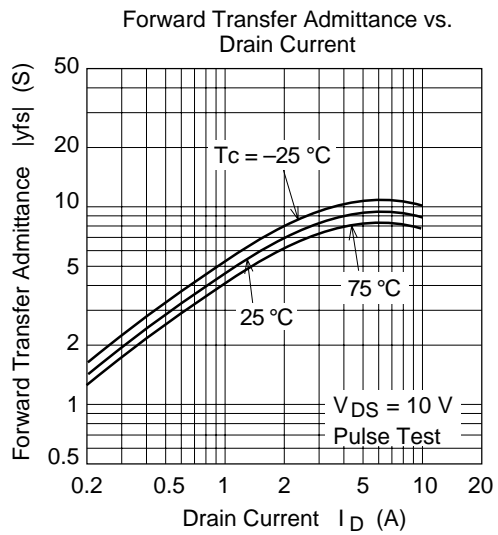
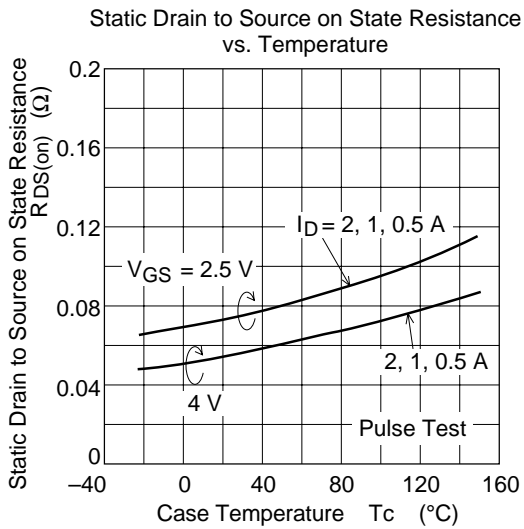
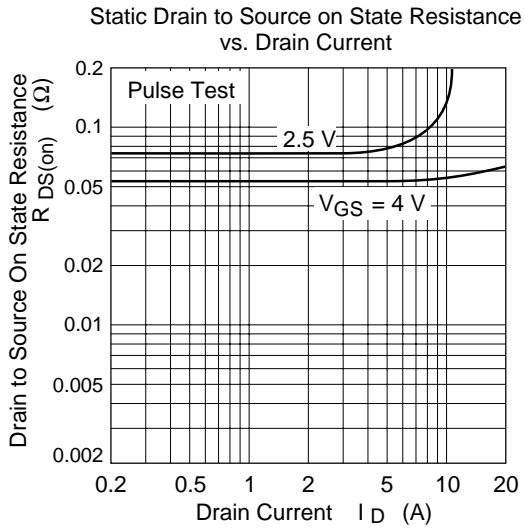
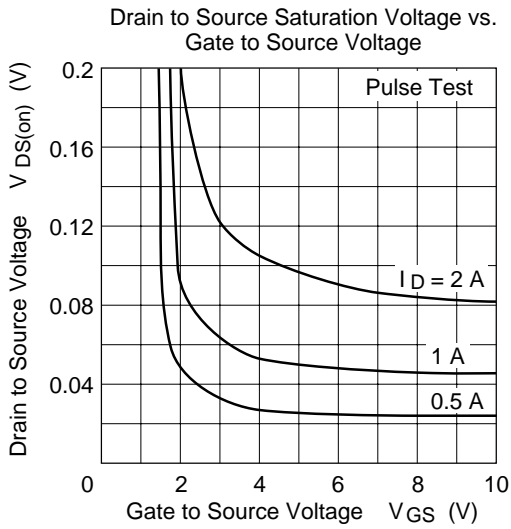
| Item | Symbol | Min | Typ | Max | Unit | Test Conditions |
|--|---------------|----------|-------|----------|----------|---|
| Drain to source breakdown voltage | $V_{(BR)DSS}$ | 20 | — | — | V | $I_D = 10\text{ mA}$, $V_{GS} = 0$ |
| Gate to source breakdown voltage | $V_{(BR)GSS}$ | ± 12 | — | — | V | $I_G = \pm 100\ \mu A$, $V_{DS} = 0$ |
| Gate to source leak current | I_{GSS} | — | — | ± 10 | μA | $V_{GS} = \pm 10\text{ V}$, $V_{DS} = 0$ |
| Zero gate voltage drain current | I_{DSS} | — | — | 1 | μA | $V_{DS} = 12\text{ V}$, $V_{GS} = 0$ |
| Gate to source cutoff voltage | $V_{GS(off)}$ | 0.5 | — | 1.5 | V | $V_{DS} = 10\text{ V}$, $I_D = 1\text{ mA}$ |
| Static drain to source on state resistance | $R_{DS(on)}$ | — | 0.054 | 0.070 | Ω | $I_D = 2\text{ A}$, $V_{GS} = 4\text{ V}$ ^{Note4} |
| | $R_{DS(on)}$ | — | 0.074 | 0.098 | Ω | $I_D = 2\text{ A}$, $V_{GS} = 2.5\text{ V}$ ^{Note4} |
| Forward transfer admittance | $ y_{fs} $ | 4.5 | 7 | — | S | $I_D = 2\text{ A}$, $V_{DS} = 10\text{ V}$ ^{Note4} |
| Input capacitance | C_{iss} | — | 300 | — | pF | $V_{DS} = 10\text{ V}$ |
| Output capacitance | C_{oss} | — | 185 | — | pF | $V_{GS} = 0$ |
| Reverse transfer capacitance | C_{rss} | — | 90 | — | pF | $f = 1\text{ MHz}$ |
| Turn-on delay time | $t_{d(on)}$ | — | 13 | — | ns | $V_{GS} = 4\text{ V}$, $I_D = 2\text{ A}$ |
| Rise time | t_r | — | 75 | — | ns | $V_{DD} \cong 10\text{ V}$ |
| Turn-off delay time | $t_{d(off)}$ | — | 60 | — | ns | |
| Fall time | t_f | — | 75 | — | ns | |
| Body-drain diode forward voltage | V_{DF} | — | 0.85 | 1.11 | V | $I_F = 3.5\text{ A}$, $V_{GS} = 0$ ^{Note4} |
| Body-drain diode reverse recovery time | t_{rr} | — | 35 | — | ns | $I_F = 3.5\text{ A}$, $V_{GS} = 0$ $diF/dt = 20\text{ A}/\mu s$ |

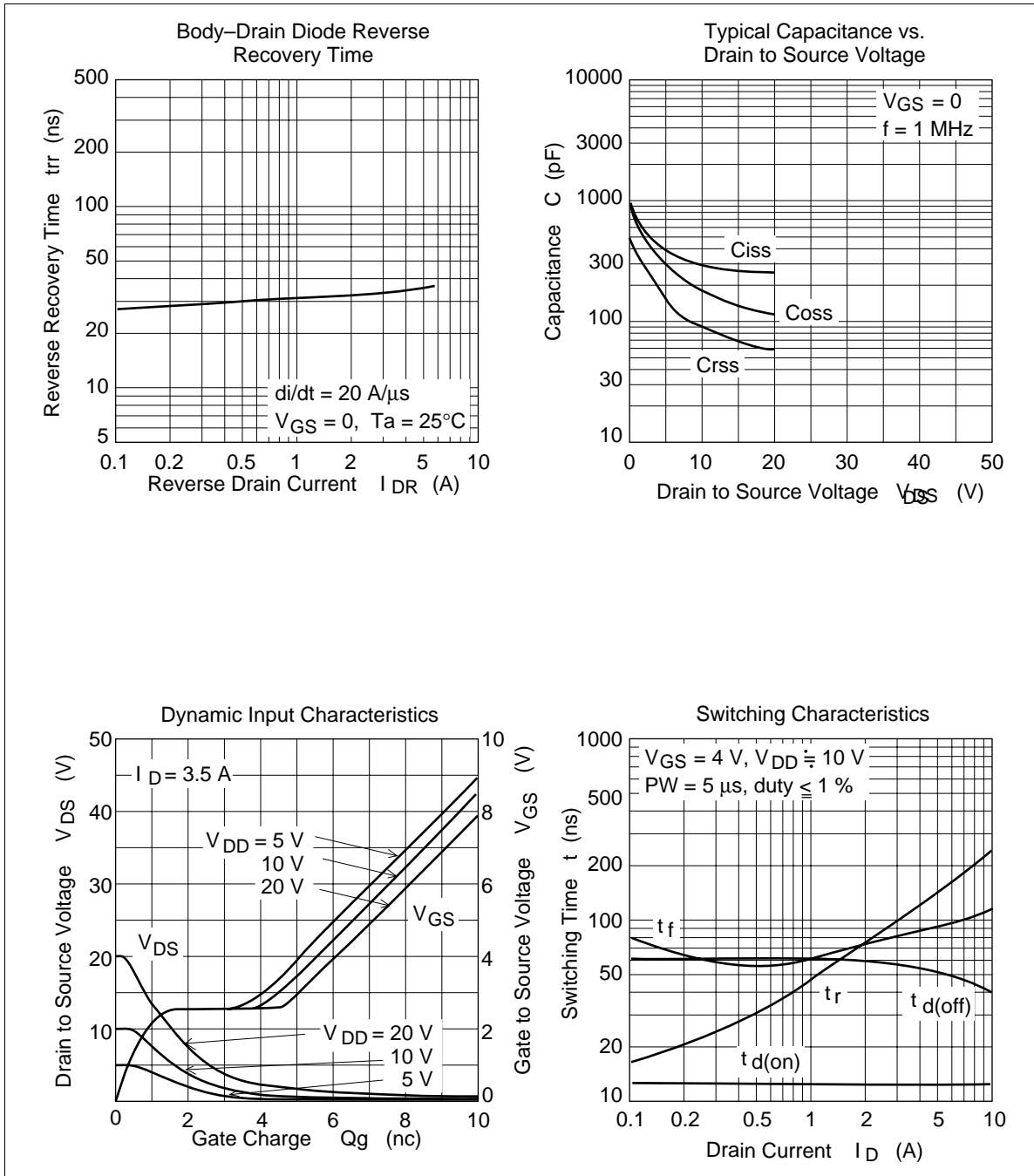
Note: 4. Pulse test

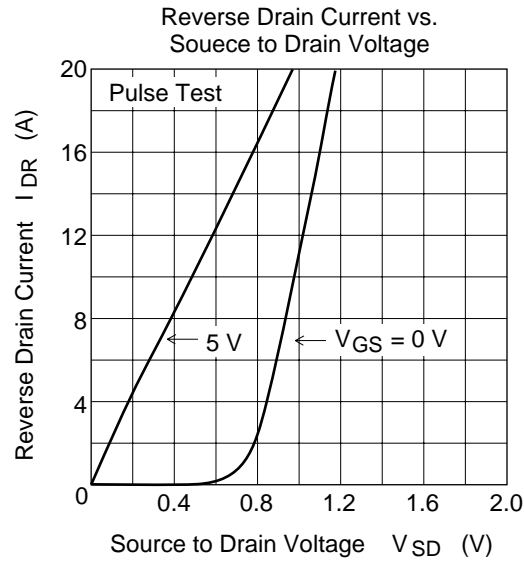
Main Characteristics



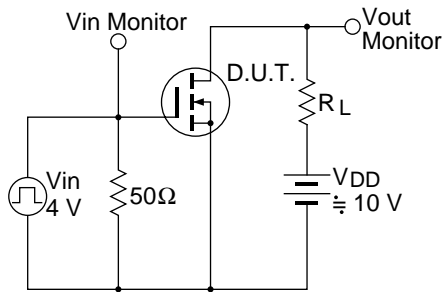
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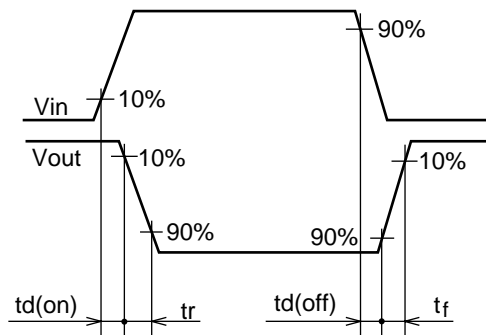


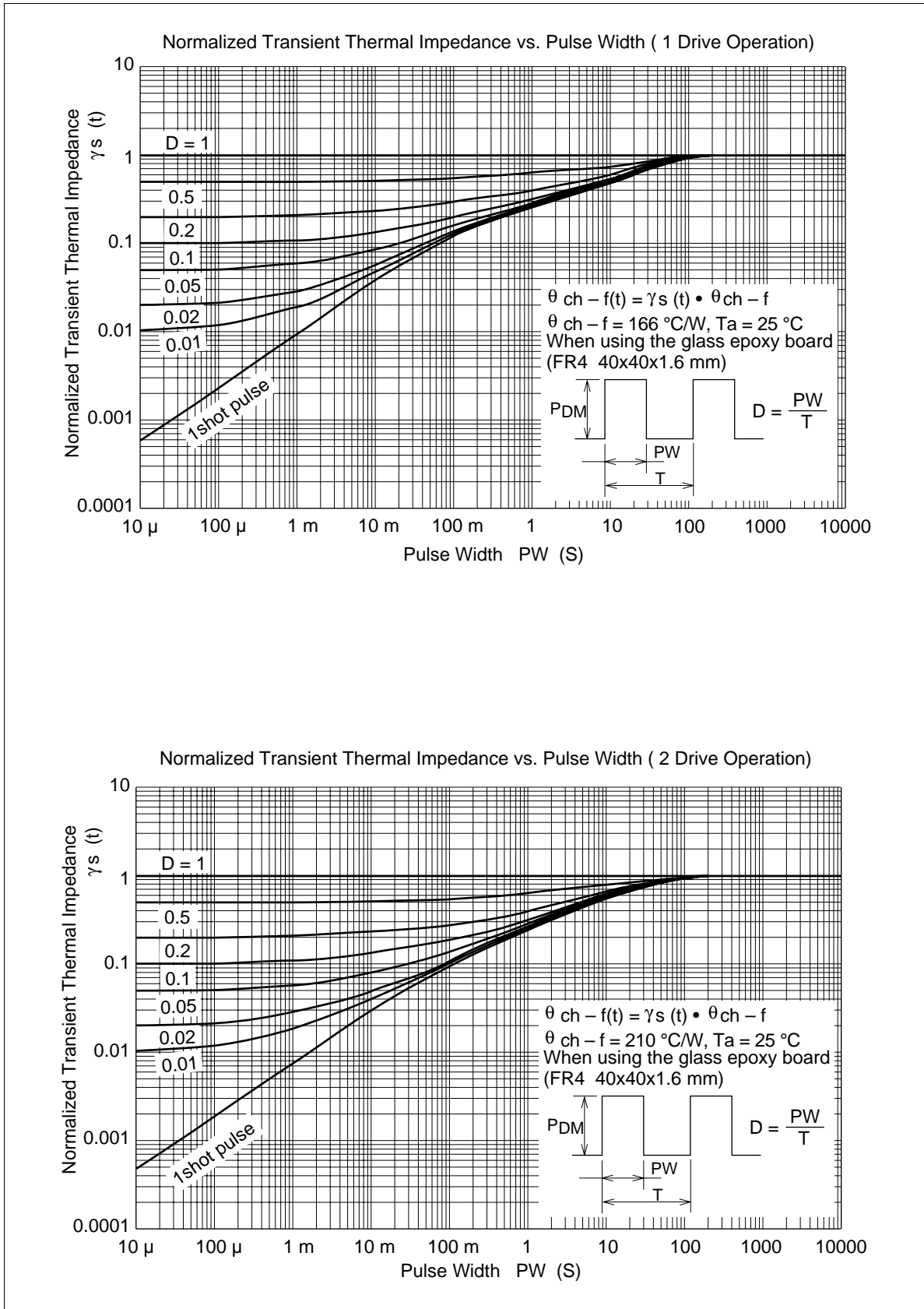


Switching Time Test Circuit



Switching Time Waveform

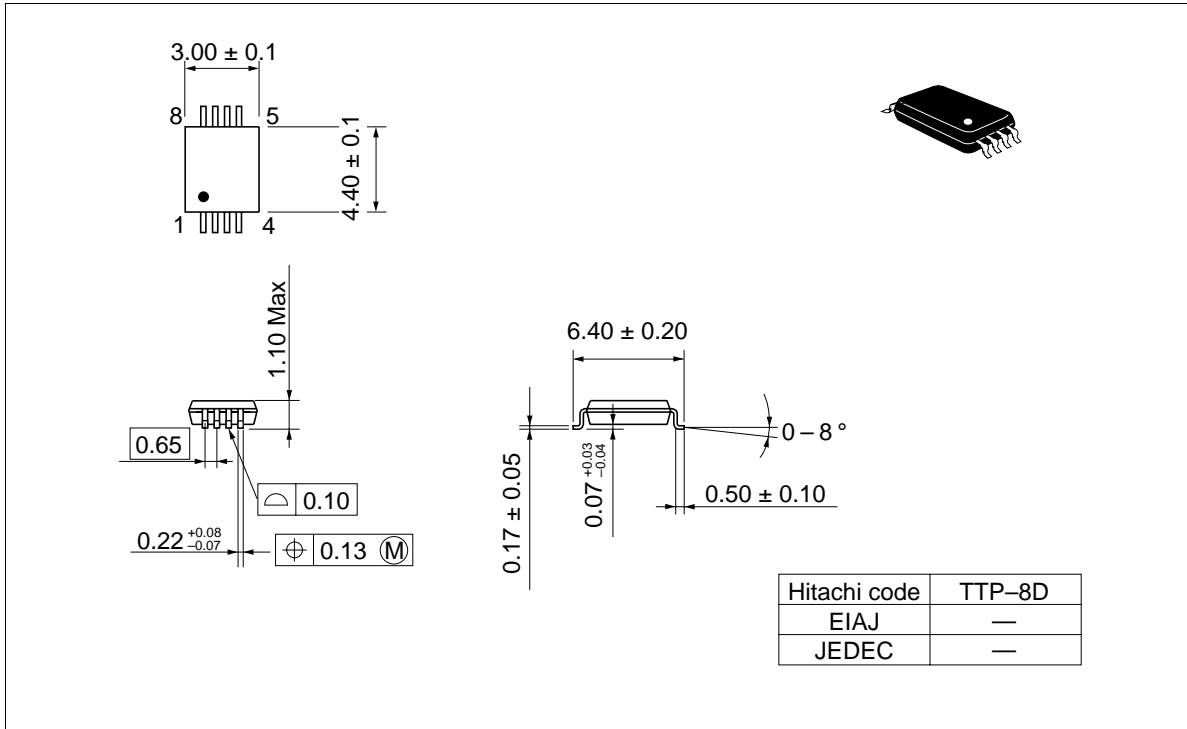




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Package Dimensions

Unit: mm



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